PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE: NEW ASSIGNMENT

NATURE OF CONVEYANCE: RELEASE BY SECURED PARTY

CONVEYING PARTY DATA

Name	Execution Date
NexBank, SSB	05/14/2010

RECEIVING PARTY DATA

Name:	Electrical Components International, Inc.	
Street Address:	One City Place	
Internal Address:	Suite 450	
City:	Saint Louis	
State/Country:	MISSOURI	
Postal Code:	63141	

PROPERTY NUMBERS Total: 1

Property Type	Number
Patent Number:	6140623

CORRESPONDENCE DATA

Fax Number: (312)993-9767

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

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Email: gayle.grocke@lw.com

Correspondent Name: Gayle D. Grocke c/o Latham & Watkins LLP

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Address Line 2: Suite 5800

Address Line 4: Chicago, ILLINOIS 60606

ATTORNEY DOCKET NUMBER: 034784-0125

NAME OF SUBMITTER: Gayle D. Grocke

Total Attachments: 4

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PATENT REEL: 024380 FRAME: 0848

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RELEASE OF SECOND LIEN PATENT SECURITY AGREEMENT

THIS RELEASE dated as of May 14, 2010 (this "Release") is made by NexBank, SSB

("NexBank") under that certain Second Lien Patent Security Agreement between Electrical

Components International, Inc. (successor by merger to Wire Harness Contractors, Inc.

("Grantor")) and NexBank dated as of May 1, 2006, and recorded in the records of the United

States Patent and Trademark Office ("PTO") at Reel 017619/Frame 0834, and that certain

Assignment and Assumption Agreement between NexBank and UBS AG, Stamford Branch,

dated as of April 3, 2009, and recorded in the records of the PTO at Reel 022494/Frame 0684

(collectively, the "Second Lien Patent Security Agreement");

 $\underline{W} \underline{I} \underline{T} \underline{N} \underline{E} \underline{S} \underline{S} \underline{E} \underline{T} \underline{H}$:

WHEREAS, pursuant to the Second Lien Patent Security Agreement, the Grantor granted

to NexBank a security interest in the patent collateral set forth on Schedule A attached hereto

(the "Patent Collateral"); and

WHEREAS, NexBank wishes to: (i) terminate the Second Lien Patent Security

Agreement against the Patent Collateral, recorded with the United States Patent and Trademark

Office; (ii) release all of its security interest in the Patent Collateral granted pursuant to the

Second Lien Patent Security Agreement; (iii) restore to Grantor all right, title and interest in and

to the Patent Collateral that NexBank was granted pursuant to the Second Lien Patent Security

Agreement; and (iv) to dissolve any and all liens and encumbrances respecting the Patent

Collateral granted to it by Grantor pursuant to the Second Lien Patent Security Agreement.

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of

which are hereby acknowledged, NexBank does hereby release its security interest in the Patent

Collateral granted pursuant to the Second Lien Patent Security Agreement, and discharges, quit

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claims and relinquishes unto Grantor (in each case without recourse and without any

representation or warranty) any and all rights, title and interest NexBank has in and to the Patent

Collateral and the security interest granted to NexBank in the Patent Collateral pursuant to the

Second Lien Patent Security Agreement.

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IN WITNESS WHEREOF, NexBank has caused this Release to be duly executed and delivered by its officer thereunto duly authorized as of the day and year first above written.

NEXBANK, SSB

By:____ Name: Title:

V Jeff Scott Vice President NexBank, SSB

[Signature Page to Release of Second Lien Patent Security Agreement]

PATENT

REEL: 024380 FRAME: 0852

SCHEDULE A

to

RELEASE OF SECOND LIEN PATENT SECURITY AGREEMENT

Patents

Mark		Registration No.
DEFROST HEATER END CAP	Electrical Components International,	6140623
	Inc.	

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RECORDED: 05/14/2010